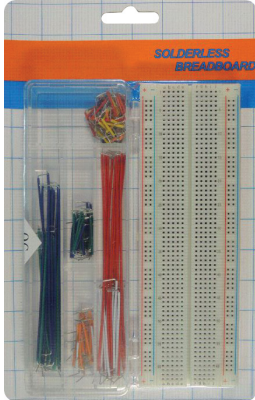


Solderless Breadboard with Wire Kit

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Kit Contents

Solderless Breadboard with 830 Tie-Points and Jumper wire kit.

Part Number Table

Description	Part Number
Prototyping Kit, Solderless Breadboard, 830 Tie-Points	21-19080

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